Date: - 21 Dec, 2000

Data Sheet Issue:- 1

Distributed Gate ThyristorTypes R325CH02 to R325CH14

Absolute Maximum Ratings

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
V_{DRM}	Repetitive peak off-state voltage, (note 1)	200-1400	V
V_{DSM}	Non-repetitive peak off-state voltage, (note 1)	200-1400	V
V_{RRM}	Repetitive peak reverse voltage, (note 1)	200-1400	V
V_{RSM}	Non-repetitive peak reverse voltage, (note 1)	300-1500	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
I _{T(AV)}	Mean on-state current, T _{sink} =55°C, (note 2)	1178	Α
$I_{T(AV)}$	Mean on-state current. T _{sink} =85°C, (note 2)	767	А
$I_{T(AV)}$	Mean on-state current. T _{sink} =85°C, (note 3)	433	Α
I _{T(RMS)}	Nominal RMS on-state current, T _{sink} =25°C, (note 2)	2395	Α
$I_{T(d.c.)}$	D.C. on-state current, T _{sink} =25°C, (note 4)	892	А
I _{TSM}	Peak non-repetitive surge t _p =10ms, V _{RM} =0.6V _{RRM} , (note 5)	17	kA
I _{TSM2}	Peak non-repetitive surge t _p =10ms, V _{RM} ≤10V, (note 5)	18.7	kA
l ² t	I^2 t capacity for fusing t_p =10ms, V_{RM} =0.6 V_{RRM} , (note 5)	1.45×10 ⁶	A ² s
l ² t	I ² t capacity for fusing t _p =10ms, V _{RM} ≤10V, (note 5)	1.75×10 ⁶	A ² s
d: /d+	Maximum rate of rise of on-state current (repetitive), (Note 6)	1000	A/µs
di _T /dt	Maximum rate of rise of on-state current (non-repetitive), (Note 6)	1500	A/µs
V_{RGM}	Peak reverse gate voltage	5	V
$P_{G(AV)}$	Mean forward gate power	2	W
P_{GM}	Peak forward gate power	30	W
V_{GD}	Non-trigger gate voltage, (Note 7)	0.25	V
T _{HS}	Operating temperature range	-40 to +125	°C
T_{stg}	Storage temperature range	-40 to +150	°C

Notes:-

- 1) De-rating factor of 0.13% per °C is applicable for T_i below 25°C.
- 2) Double side cooled, single phase; 50Hz, 180° half-sinewave.
- 3) Single side cooled, single phase; 50Hz, 180° half-sinewave.
- 4) Double side cooled.
- 5) Half-sinewave, 125°C T_j initial.
- 6) $V_D=67\%\ V_{DRM},\ I_{FG}=2A,\ t_r\leq 0.5\mu s,\ T_{case}=125^{\circ}C.$
- 7) Rated V_{DRM}.

Characteristics

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS (Note 1)	UNITS	
V_{TM}	Maximum peak on-state voltage	-	-	2.2	I _{TM} =2000A	V	
V_0	Threshold voltage	-	-	1.6		V	
rs	Slope resistance	-	-	0.3		mΩ	
dv/dt	Critical rate of rise of off-state voltage	-	-	200	V _D =80% V _{DRM}	V/μs	
I_{DRM}	Peak off-state current	-	-	150	Rated V _{DRM}	mΛ	
I_{RRM}	Peak reverse current	-	-	150	Rated V _{RRM}	mA	
V_{GT}	Gate trigger voltage	-	-	3.0	T _j =25°C	V	
I_{GT}	Gate trigger current	-	-	300	T_{j} =25°C V_{D} =10V, I_{T} =2A	mA	
IH	Holding current	-	-	1000	T _j =25°C	mA	
Qra	Recovered charge, 50% Chord	-	170	190	I_{TM} =1000A, t_p =1000 μ s, di/dt=60A/ μ s, V_r =50V	μC	
tq	Turn-off time	-	-	35	I _{TM} =1000A, t _p =1000μs, di/dt=60A/μs, V _r =50V, V _{dr} =80%V _{DRM} , dV _{dr} /dt=20V/μs	μs	
•4	Tan on and	25	-	40	I_{TM} =1000A, t_p =1000 μ s, di/dt =60A/ μ s, V_r =50V, V_{dr} =80% V_{DRM} , dV_{dr}/dt =200V/ μ s	μο	
R_{θ}	Thermal resistance, junction to	-	-	0.024	Double side cooled	K/W	
9	heatsink	-	-	0.048	Single side cooled	IVVV	
F	Mounting force	19	-	26		kN	
W_t	Weight	-	510	-		g	

Notes:-

1) Unless otherwise indicated T_j=125°C.

Notes on Ratings and Characteristics

1.0 Voltage Grade Table

Voltage Grade 'H'	$V_{DRM} V_{DSM} V_{RRM} V$	V _{RSM} V	V _D V _R DC V
02	200	210	140
04	400	410	260
06	600	610	420
08	800	810	560
10	1000	1100	700
12	1200	1300	810
14	1400	1400	930

2.0 Extension of Voltage Grades

This report is applicable to other and higher voltage grades when supply has been agreed by Sales/Production.

3.0 Extension of Turn-off Time

This Report is applicable to other t_q /re-applied dv/dt combinations when supply has been agreed by Sales/Production.

4.0 Repetitive dv/dt

Higher dv/dt selections are available up to 1000V/µs on request.

5.0 De-rating Factor

A blocking voltage de-rating factor of 0.13%/°C is applicable to this device for T_i below 25°C.

6.0 Rate of rise of on-state current

The maximum un-primed rate of rise of on-state current must not exceed 1500A/µs at any time during turn-on on a non-repetitive basis. For repetitive performance, the on-state rate of rise of current must not exceed 1000A/µs at any time during turn-on. Note that these values of rate of rise of current apply to the total device current including that from any local snubber network.

7.0 Square wave ratings

These ratings are given for load component rate of rise of forward current of 100 and 500A/µs.

8.0 Duty cycle lines

The 100% duty cycle is represented on all the ratings by a straight line. Other duties can be included as parallel to the first.

9.0 Maximum Operating Frequency

The maximum operating frequency is set by the on-state duty, the time required for the thyristor to turn off (t_0) and for the off-state voltage to reach full value (t_v) , i.e.

$$f_{\max} = \frac{1}{t_{pulse} + t_q + t_v}$$

10.0 On-State Energy per Pulse Characteristics

These curves enable rapid estimation of device dissipation to be obtained for conditions not covered by the frequency ratings.

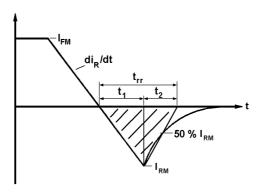
Let E_p be the Energy per pulse for a given current and pulse width, in joules Let $R_{th(J-Hs)}$ be the steady-state d.c. thermal resistance (junction to sink) and T_{SINK} be the heat sink temperature.

Then the average dissipation will be:

$$W_{AV} = E_P \cdot f \text{ and } T_{SINK \text{(max.)}} = 125 - (W_{AV} \cdot R_{th(J-Hs)})$$

11.0 Reverse recovery ratings

(i) Q_{ra} is based on 50% I_{rm} chord as shown in Fig. 1 below.



Fia. 1

(ii) Q_{rr} is based on a 150μs integration time.

i.e.
$$Q_{rr} = \int_{0}^{150 \, \mu s} i_{rr}.dt$$

(iii)
$$K Factor = \frac{t1}{t2}$$

12.0 Reverse Recovery Loss

12.1 Determination by Measurement

From waveforms of recovery current obtained from a high frequency shunt (see Note 1, Page 5) and reverse voltage present during recovery, an instantaneous reverse recovery loss waveform must be constructed. Let the area under this waveform be E joules per pulse. A new heat sink temperature can then be evaluated from the following:

$$T_{SINK(new)} = T_{SINK(original)} - E \cdot (k + f \cdot R_{th(J-Hs)})$$

where k = 0.227 (°C/W)/s

E = Area under reverse loss waveform per pulse in joules (W.s)

f = Rated frequency (in Hz) at the original heat sink temperature

 $R_{th(J-Hs)} = D.C.$ thermal resistance (°C/W)

The total dissipation is now given by:

$$W_{(TOT)} = W_{(original)} + E \cdot f$$

12.2 Determination without Measurement

In circumstances where it is not possible to measure voltage and current conditions, or for design purposes, the additional losses E in joules may be estimated as follows.

Let E be the value of energy per reverse cycle in joules (curves in Figure 9). Let f be the operating frequency in Hz

$$T_{SINK(new)} = T_{SINK(original)} - (E \cdot R_{th} \cdot f)$$

Where $T_{SINK (new)}$ is the required maximum heat sink temperature and $T_{SINK (original)}$ is the heat sink temperature given with the frequency ratings.

A suitable R-C snubber network is connected across the thyristor to restrict the transient reverse voltage to a peak value (V_{rm}) of 67% of the maximum grade. If a different grade is being used or V_{rm} is other than 67% of Grade, the reverse loss may be approximated by a pro rata adjustment of the maximum value obtained from the curves.

NOTE 1- Reverse Recovery Loss by Measurement

This thyristor has a low reverse recovered charge and peak reverse recovery current. When measuring the charge care must be taken to ensure that:

- (a) a.c. coupled devices such as current transformers are not affected by prior passage of high amplitude forward current.
- (b) A suitable, polarised, clipping circuit must be connected to the input of the measuring oscilloscope to avoid overloading the internal amplifiers by the relatively high amplitude forward current signal
- (c) Measurement of reverse recovery waveform should be carried out with an appropriate critically damped snubber, connected across diode anode to cathode. The formula used for the calculation of this snubber is shown below:

$$R^2 = 4 \cdot \frac{V_r}{C_S \cdot \frac{di}{dt}}$$

Where: V_r = Commutating source voltage

C_S = Snubber capacitance R = Snubber resistance

13.0 Gate Drive

The recommended pulse gate drive is 20V, 10Ω with a short-circuit current rise time of not more than 0.5µs. This gate drive must be applied when using the full di/dt capability of the device.

The duration of pulse may need to be configured with respect to the application but should be no shorter than 20µs, otherwise an increase in pulse current could be needed to supply the necessary charge to trigger the device.

14.0 Computer Modelling Parameters

14.1 Calculating V_T using ABCD Coefficients

The on-state characteristic I_T vs. V_T , on page 7 is represented in two ways;

- (i) the well established V₀ and r_s tangent used for rating purposes and
- (ii) a set of constants A, B, C, D, forming the coefficients of the representative equation for V_T in terms of I_T given below:

$$V_T = A + B \cdot \ln(I_T) + C \cdot I_T + D \cdot \sqrt{I_T}$$

The constants, derived by curve fitting software, are given in this report for hot characteristics where possible. The resulting values for V_T agree with the true device characteristic over a current range, which is limited to that plotted.

125°C Coefficients					
A 0.62329615					
B 0.2341749					
С	4.506305×10 ⁻⁴				
D	-0.02469732				

14.2 D.C. Thermal Impedance Calculation

$$r_t = \sum_{p=1}^{p=n} r_p \cdot \left(1 - e^{\frac{-t}{\tau_p}}\right)$$

Where p = 1 to n, n is the number of terms in the series.

t = Duration of heating pulse in seconds.

 r_t = Thermal resistance at time t.

 r_p = Amplitude of p_{th} term.

 τ_p = Time Constant of r_{th} term.

D.C. Double Side Cooled							
Term 1 2 3 4 5							
r_p	0.01249139	6.316833×10 ⁻³	1.850855×10 ⁻³	1.922045×10 ⁻³	6.135330×10 ⁻⁴		
$ au_{ m p}$	0.8840810	0.1215195	0.03400152	6.742908×10 ⁻³	1.326292×10 ⁻³		

D.C. Single Side Cooled							
Term 1 2 3 4 5 6							
r_p	0.02919832	4.863568×10 ⁻³	3.744798×10 ⁻³	6.818034×10 ⁻³	2.183558×10 ⁻³	1.848294×10 ⁻³	
$ au_{ ho}$	6.298105	3.286174	0.5359179	0.1186897	0.02404574	3.379476×10 ⁻³	

Curves

Figure 1 - On-state characteristics of Limit device

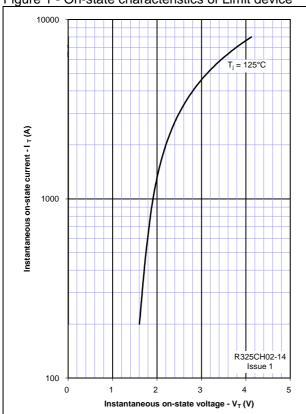


Figure 2 - Transient thermal impedance

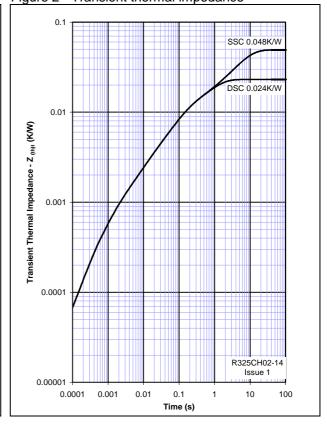


Figure 3 - Gate characteristics - Trigger limits

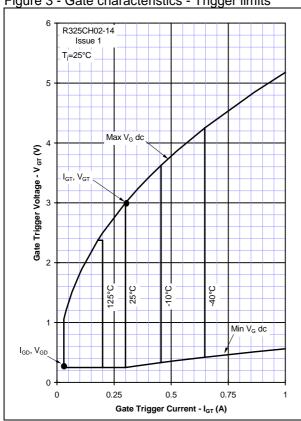
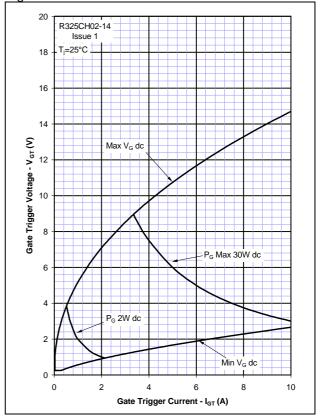
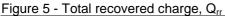


Figure 4 - Gate characteristics - Power curves





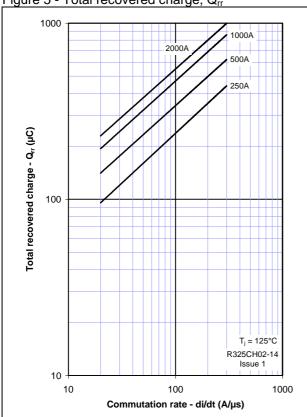


Figure 6 - Recovered charge, Q_{ra} (50% chord)

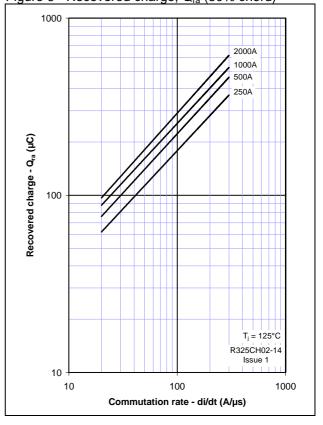


Figure 7 - Peak reverse recovery current, I_{rm}

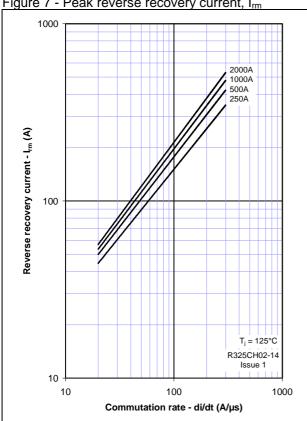
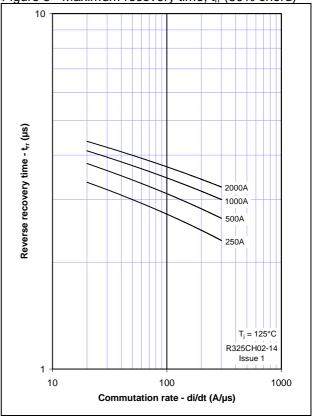
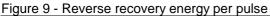


Figure 8 - Maximum recovery time, t_{rr} (50% chord)





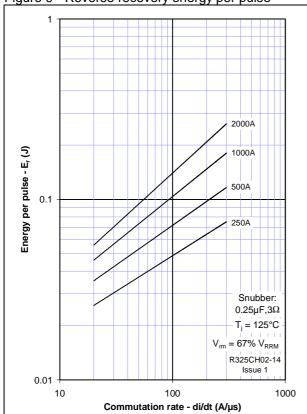


Figure 10 - Sine wave energy per pulse

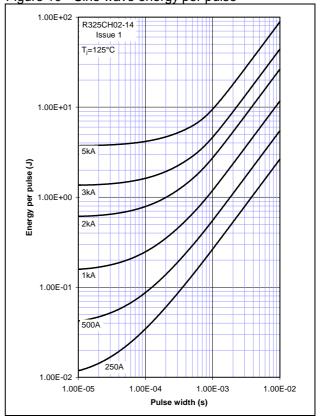


Figure 11 - Sine wave frequency ratings

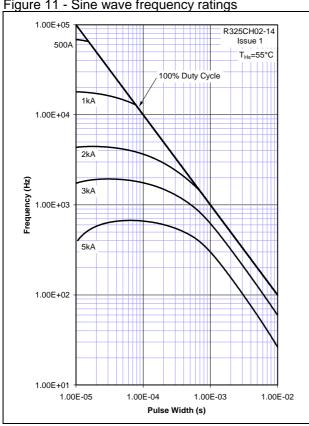
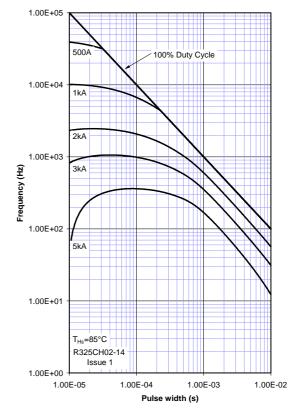
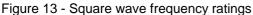


Figure 12 - Sine wave frequency ratings





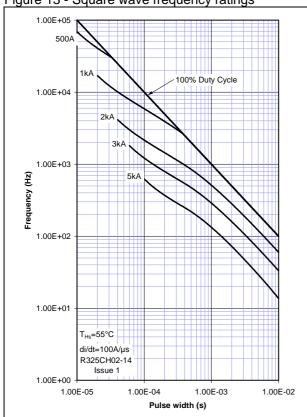


Figure 14 - Square wave frequency ratings

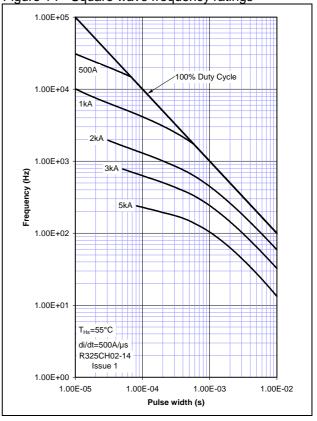


Figure 15 - Square wave frequency ratings

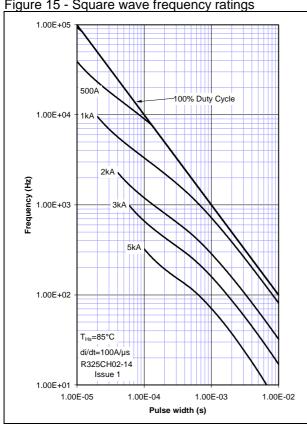
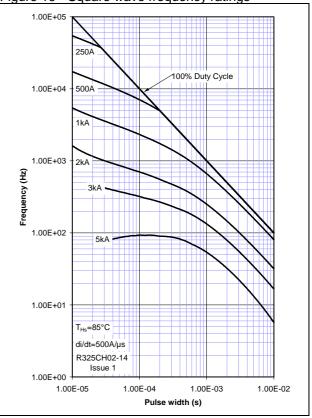


Figure 16 - Square wave frequency ratings





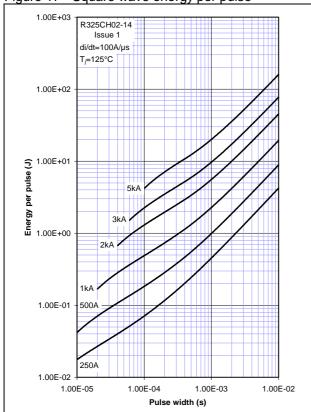


Figure 18 - Square wave energy per pulse

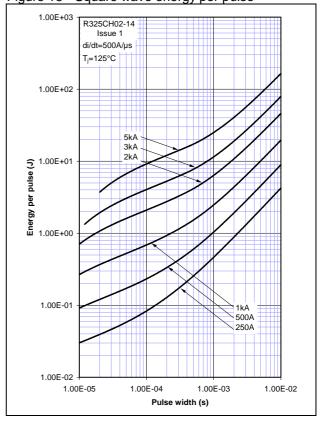
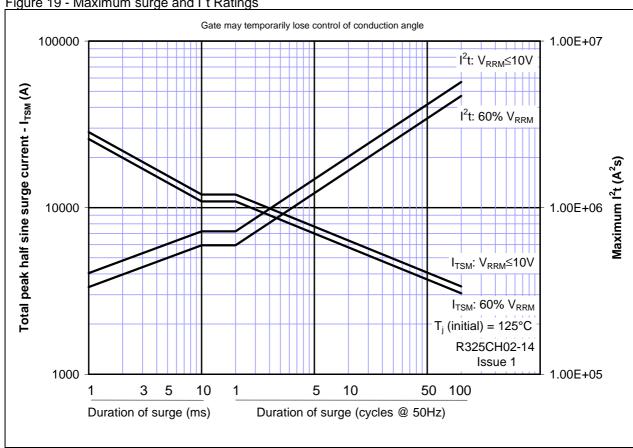
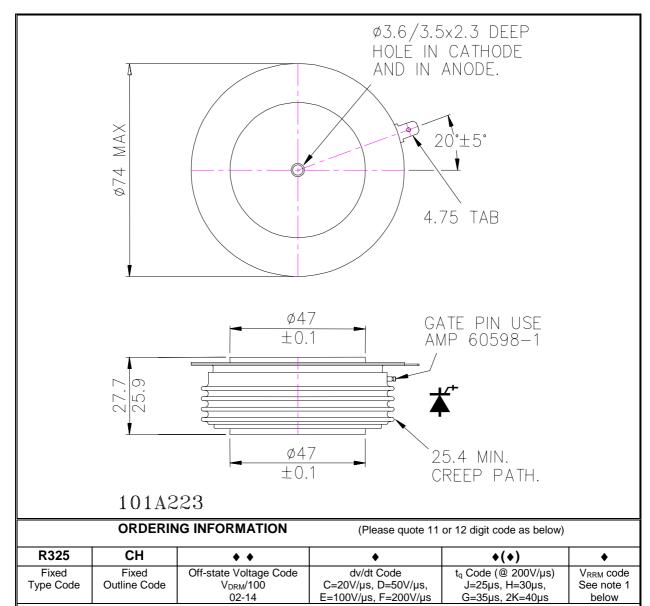


Figure 19 - Maximum surge and I²t Ratings



Outline Drawing & Ordering Information



Note 1.: A single digit represents V_{RRM} in 10% increments of the selected V_{DRM}.

A zero in this position indicates that V_{RRM} =100% V_{DRM} . The examples shown below are for 70% and 100% respectively. Typical order code: R325CH10F2K7 – 1000V V_{DRM} , 700V V_{RRM} , 200V/ μ s dv/dt, 40 μ s t_q, 27.7mm clamp height capsule. Typical order code: R325CH10F2K0 – 1000V V_{DRM} , 1000V V_{RRM} , 200V/ μ s dv/dt, 40 μ s t_q, 27.7mm clamp height capsule.

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